

# FP0708

## High frequency, high current power inductors



### Applications

- Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs)
  - Server and desktop
  - Central processing unit (CPU)
  - Graphics processing unit (GPU)
  - Application specific integrated circuit (ASIC)
  - High power density
- Data networking and storage systems
- Graphics cards and battery power systems
- Portable electronics
- Point-of-Load modules

### Product description

- High current carrying capacity
- Low core loss
- Frequency range up to 2 MHz
- Inductance Range from 72 nH to 200 nH
- Current range from 36 A to 90 A
- 7.0 mm x 8.5 mm footprint surface mount package in a 7.2 mm height
- Ferrite core material
- Halogen free, lead free, RoHS compliant

### Environmental data

- Storage temperature range (Component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant



## Product specifications

Part Number <sup>7</sup>	OCL <sup>1</sup> (nH) ±10%	FLL <sup>2</sup> (nH) minimum	I <sub>rms</sub> <sup>3</sup> (A)	I <sub>sat</sub> <sup>4</sup> (A)	I <sub>sat</sub> <sup>2</sup> <sup>5</sup> (A)	DCR (mΩ) ± 8.6% @ 20°C	K-factor <sup>6</sup>
FP0708R1-R07-R	72	52	44	90	72	0.35	557
FP0708R1-R09-R	90	64	44	75	60	0.35	557
FP0708R1-R10-R	105	75	44	68	54	0.35	557
FP0708R1-R12-R	120	86	44	59	47	0.35	557
FP0708R1-R15-R	150	108	44	47	37	0.35	557
FP0708R1-R19-R	190	135	44	37	29	0.35	557
FP0708R1-R20-R	200	144	44	36	27	0.35	557

1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.1Vrms, 0.0 Adc, +25 °C
2. Full Load Inductance (FLL) Test Parameters: 100 kHz, 0.1 Vrms, I<sub>sat</sub>1, +25 °C
3. I<sub>rms</sub>: DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125 °C under worst case operating conditions verified in the end application.
4. I<sub>sat</sub>1: Peak current for approximately 20% rolloff @ +25 °C
5. I<sub>sat</sub>2: Peak current for approximately 20% rolloff @ +125 °C

6. K-factor: Used to determine B<sub>pp</sub> for core loss (see graph).  
 $B_{pp} = K * L * \Delta I * 10^3$ . B<sub>pp</sub> (Gauss), K: (K-factor from table),  
L: (Inductance in nH), ΔI (Peak to peak ripple current in Amps).

7. Part Number Definition: FP0708Rx-Rxx-R

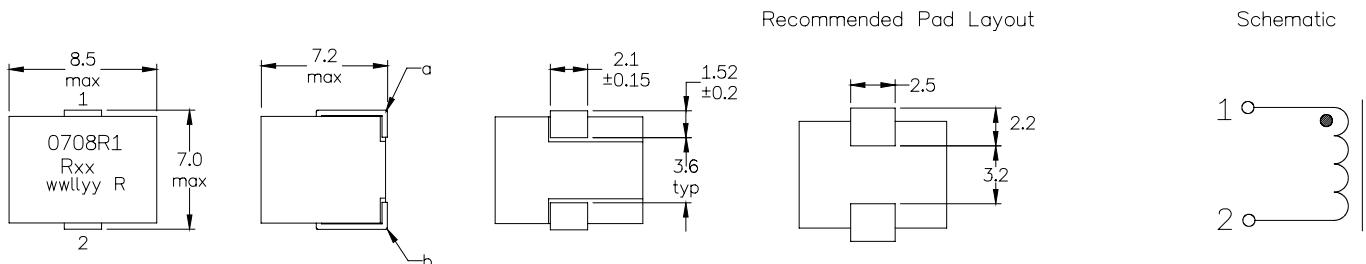
Rx= Product code and size

Rxx= Version indicator

-Rxx= Inductance value in μH, R= decimal point

-R suffix = RoHS compliant

## Dimensions (mm)



Part marking: 0708Rx (Rx = version indicator), Rxx = Inductance value in uH, R = decimal point, wwllyy = date code, R = revision level

Tolerances are ±0.15 millimeters unless stated otherwise

PCB tolerances are ±0.1 millimeters unless stated otherwise

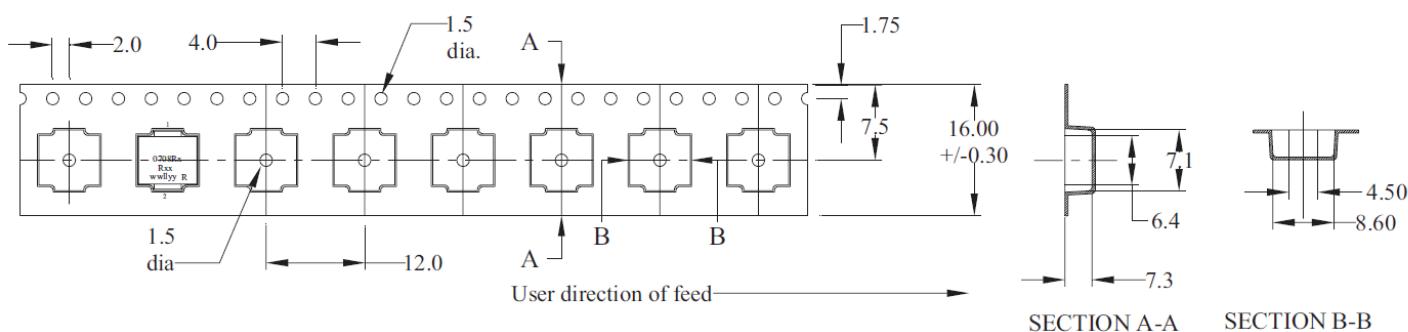
All soldering surface to be coplanar within 0.1016 millimeters

DCR measured between point "a" and point "b"

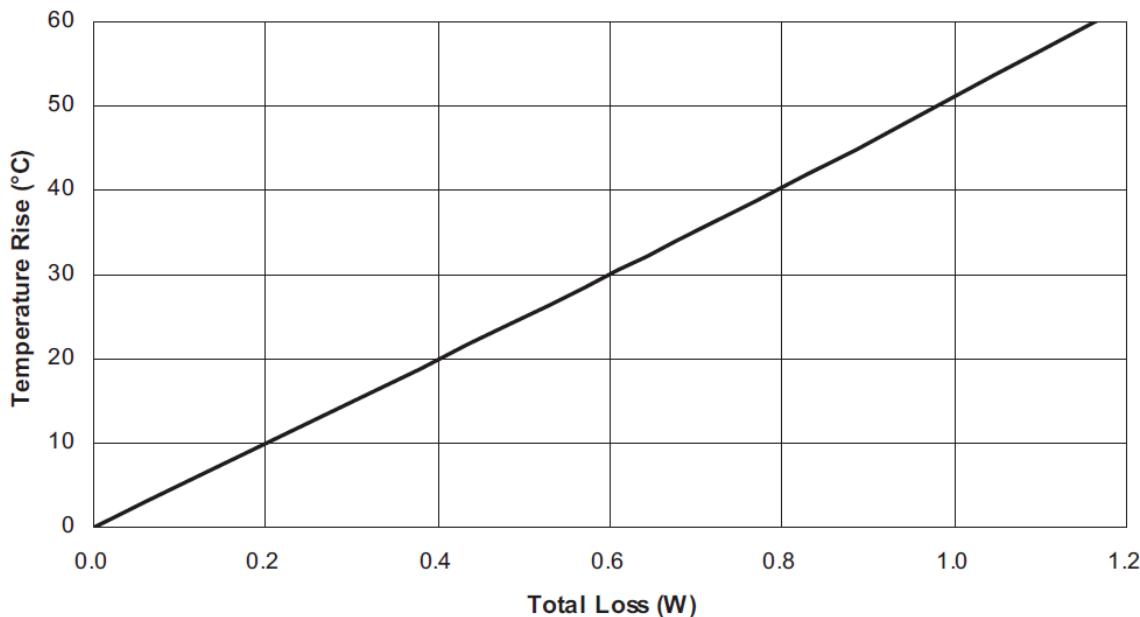
Do not route traces or vias underneath the inductor

## Packaging information (mm)

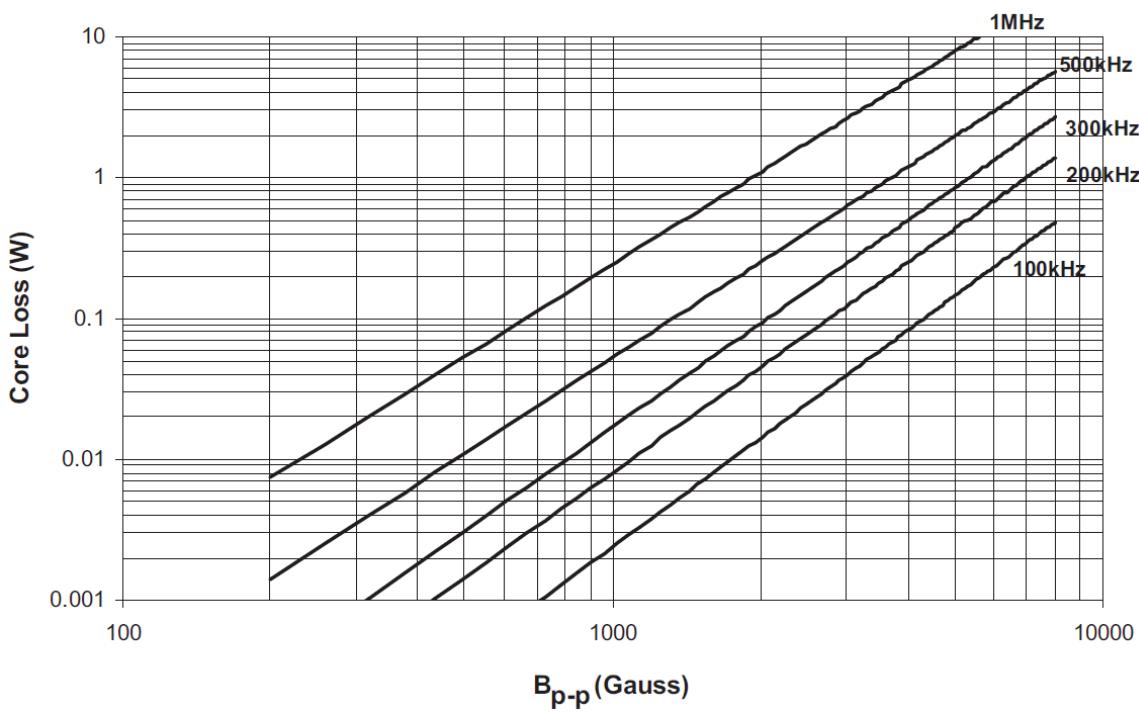
Supplied in tape and reel packaging , 640 parts per 13" diameter reel



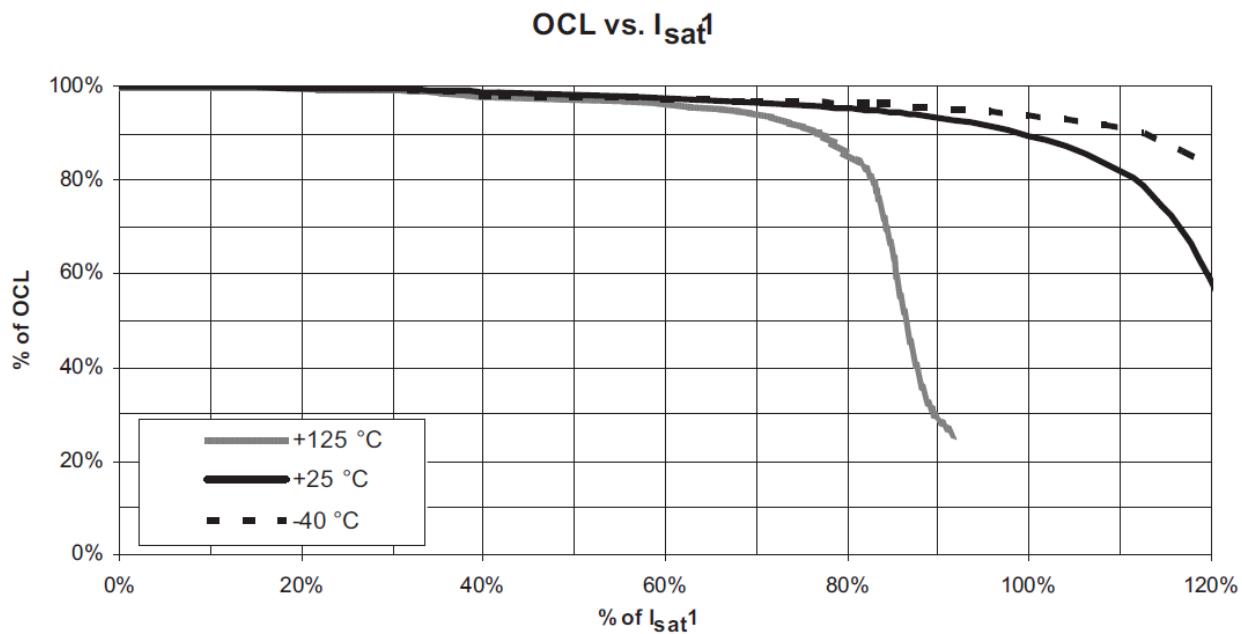
Temperature rise vs. total loss



Core loss vs.  $B_{\text{p-p}}$



### Inductance characteristics



### Solder reflow profile

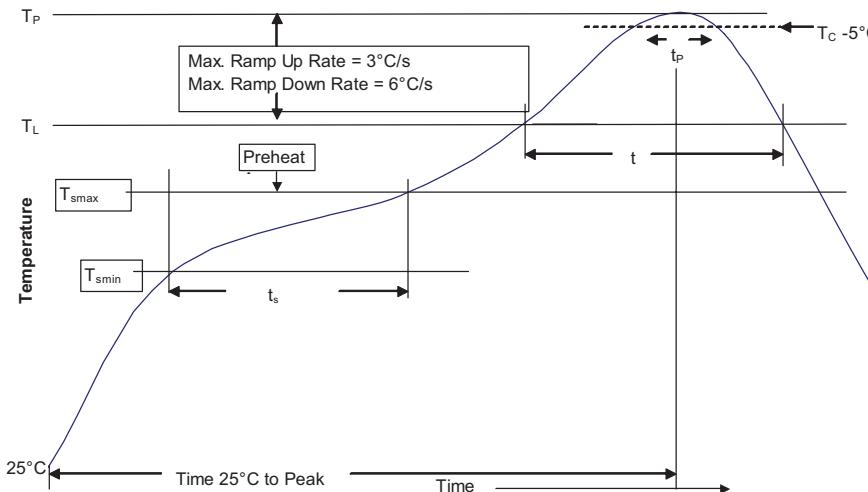


Table 1 - Standard SnPb Solder ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

### Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	<ul style="list-style-type: none"> <li>Temperature min. (<math>T_{smin}</math>)</li> <li>Temperature max. (<math>T_{smax}</math>)</li> <li>Time (<math>T_{smin}</math> to <math>T_{smax}</math>) (<math>t_s</math>)</li> </ul>	100°C 150°C 60-120 Seconds 60-120 Seconds
Average ramp up rate $T_{smax}$ to $T_p$	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature ( $T_L$ )	183°C	217°C
Time at liquidous ( $t_L$ )	60-150 Seconds	60-150 Seconds
Peak package body temperature ( $T_p$ )*	Table 1	Table 2
Time ( $t_p$ )** within 5 °C of the specified classification temperature ( $T_c$ )	20 Seconds**	30 Seconds**
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

\* Tolerance for peak profile temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.

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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
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